

## **Features**

- · Ideally Suited for Automatic Insertion
- · Low Current, Low Voltage
- · Epitaxial Planar Die Construction
- · Halogen Free. "Green" Device (Note 1)
- · Moisture Sensitivity Level 1
- · Epoxy Meets UL 94 V-0 Flammability Rating
- Lead Free Finish/RoHS Compliant ("P" Suffix Designates RoHS Compliant. See Ordering Information)

# Maximum Ratings @ 25°C Unless Otherwise Specified

- Operating Junction Temperature Range: -55°C to +150°C
- Storage Temperature Range: -55°C to +150°C
- Thermal Resistance: 285°C/W Junction to Ambient(Note 2)
- · Thermal Resistance: 215°C/W Junction to Soldering Point

Parameter	Symbol	Rating	Unit	
Collector-Base Voltage		V <sub>CBO</sub>	-60	V
Collector-Emitter Volta	V <sub>CEO</sub>	-45	V	
Emitter-Base Voltage	V <sub>EBO</sub>	-5	V	
Continuous Collector Current		Ic	-800	mA
Peak Collector Current		I <sub>CM</sub>	-1000	mA
Continuous Base Current		I <sub>B</sub>	-100	mA
Peak Base Current		I <sub>BM</sub>	-200	mA
Power Dissipation	T <sub>S</sub> =79°C	P <sub>D</sub>	330	mW

Note: 1. Halogen free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and <1000ppm antimony compounds.

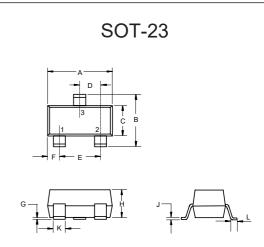
2. Valid Provided that Leads are Kept at Ambient Temperature.

## Marking: DH

## **Internal Structure**

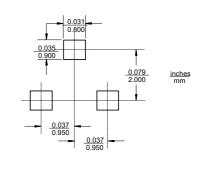


# PNP Small Signal Transistor



DIMENSIONS					
DIM INCH		HES	MM		NOTE
DIIVI	MIN	MAX	MIN	MAX	NOTE
Α	0.110	0.120	2.80	3.04	
В	0.083	0.104	2.10	2.64	
С	0.047	0.055	1.20	1.40	
D	0.034	0.041	0.85	1.05	
E	0.067	0.083	1.70	2.10	
F	0.018	0.024	0.45	0.60	
G	0.0004	0.006	0.01	0.15	
Н	0.035	0.043	0.90	1.10	
J	0.003	0.007	0.08	0.18	
K	0.012	0.020	0.30	0.51	
L	0.007	0.020	0.20	0.50	

# Suggested Solder Pad Layout



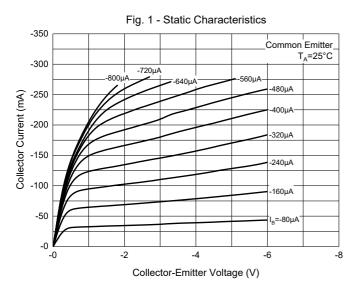


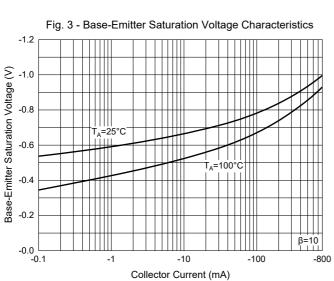
# Electrical Characteristics @ $T_A=25^{\circ}C$ Unless Otherwise Specified

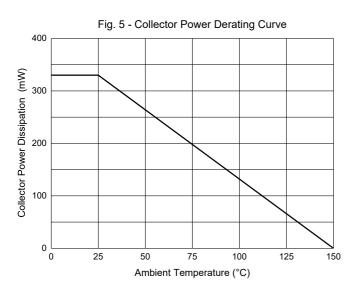
Parameter	Symbol	Min	Тур	Max	Units	Conditions
Collector-Base Breakdown Voltage	V <sub>(BR)CBO</sub>	-60			V	I <sub>C</sub> =-10μA, I <sub>E</sub> =0
Collector-Emitter Breakdown Voltage	$V_{(BR)CEO}$	-45			V	I <sub>C</sub> =-10mA, I <sub>B</sub> =0
Emitter-Base Breakdown Voltage	V <sub>(BR)EBO</sub>	-5			V	I <sub>E</sub> =-10μA, I <sub>C</sub> =0
Collector-Base Cutoff Current	I <sub>CBO</sub> -			-20	nA	V <sub>CB</sub> =-45V, I <sub>E</sub> =0
				-20	μA	V <sub>CB</sub> =-45V, I <sub>E</sub> =0, T <sub>A</sub> =150°C
Emitter-Base Cutoff Current	I <sub>EBO</sub>			-20	nA	V <sub>EB</sub> =-4V, I <sub>C</sub> =0
DC Current Gain	h <sub>FE(1)</sub>	180				V <sub>CE</sub> =-1V, I <sub>C</sub> =-10mA
	h <sub>FE(2)</sub>	250		630		V <sub>CE</sub> =-2V, I <sub>C</sub> =-100mA
	h <sub>FE(3)</sub>	100				V <sub>CE</sub> =-2V, I <sub>C</sub> =-500mA
Collector-Emitter Saturation Voltage	V <sub>CE(sat)</sub>			-0.3	V	I <sub>C</sub> =-100mA, I <sub>B</sub> =-10mA
				-1.0	V	I <sub>C</sub> =-500mA, I <sub>B</sub> =-50mA
Base-Emitter Saturation Voltage	V <sub>BE(sat)</sub>			-1.25	V	I <sub>C</sub> =-100mA, I <sub>B</sub> =-10mA
				-2.0	V	I <sub>C</sub> =-500mA, I <sub>B</sub> =-50mA
Transition Frequency	f <sub>T</sub>		100		MHz	V <sub>CE</sub> =-10V,I <sub>C</sub> =-20mA,f=100MHz
Collector-Base Capacitance	C <sub>CB</sub>		6		pF	V <sub>CB</sub> =-10V, f=1MHz
Emitter-Base Capacitance	C <sub>EB</sub>		60		pF	V <sub>EB</sub> =-0.5V, f=1MHz

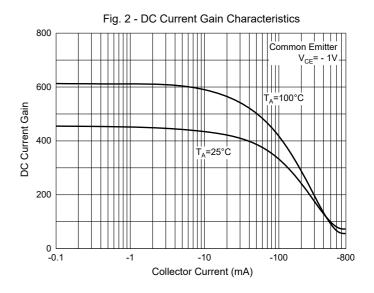


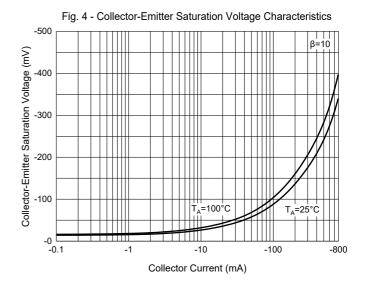
## **Curve Characteristics**













# **Ordering Information**

Device	Packing
Part Number-TP	Tape&Reel: 3Kpcs/Reel

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